

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
30V	2mΩ@10V	100A
	3mΩ@4.5V	

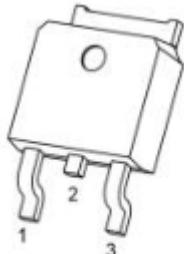
Feature

- Fast Switching
- Low Gate Charge and Rdson
- 100% Single Pulse avalanche energy Test

Application

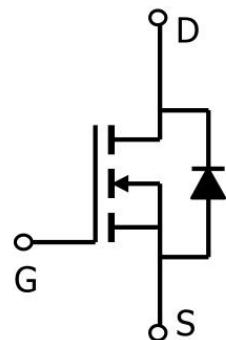
- Power switching application
- DC-DC Converter
- Power Management

Package

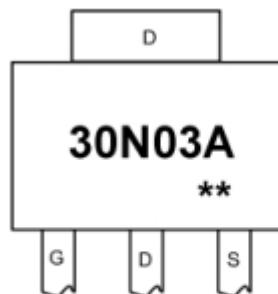


TO-252(1:G 2:D 3:S)

Circuit diagram



Marking



30N03A : Product code
** : Week code

Absolute maximum ratings

($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain source voltage	V_{DS}	30	V
Gate source voltage	V_{GS}	± 20	V
Continuous drain current($T_c=25^\circ\text{C}$)	I_D	100	A
Pulsed drain current	I_{DM}	400	A
Power dissipation($T_c=25^\circ\text{C}$)	P_D	115	W
Single pulsed avalanche energy ¹⁾	E_{AS}	245	mJ
Thermal resistance, junction-case	$R_{\theta JC}$	1.08	$^\circ\text{C}/\text{W}$
Operation and storage temperature	T_{STG}, T_J	-55 to 150	$^\circ\text{C}$

Electrical characteristics

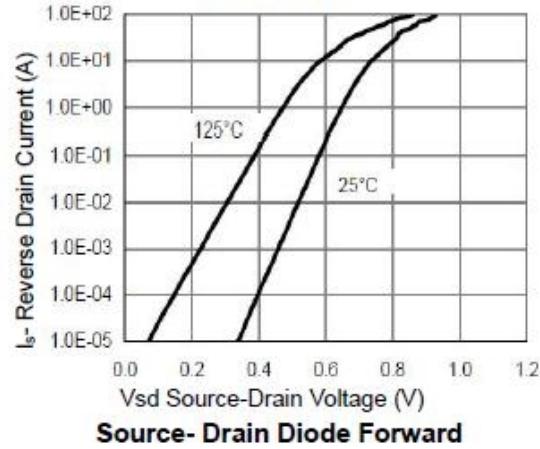
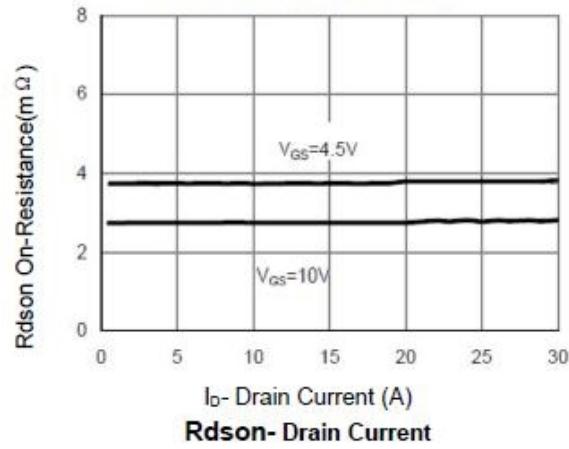
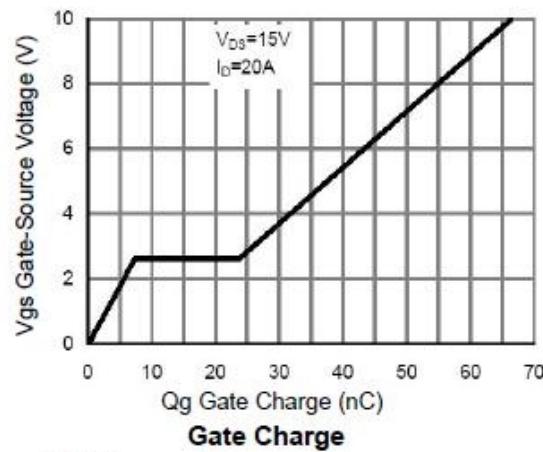
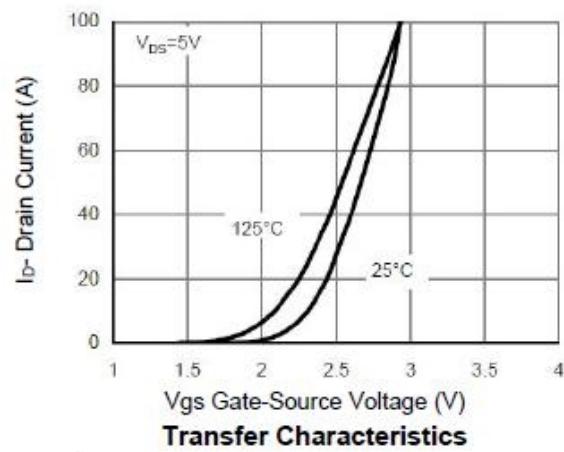
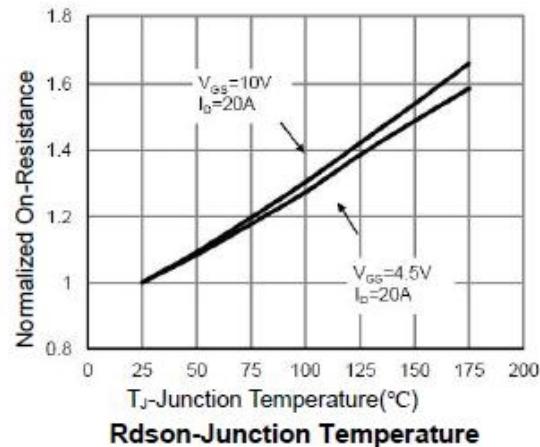
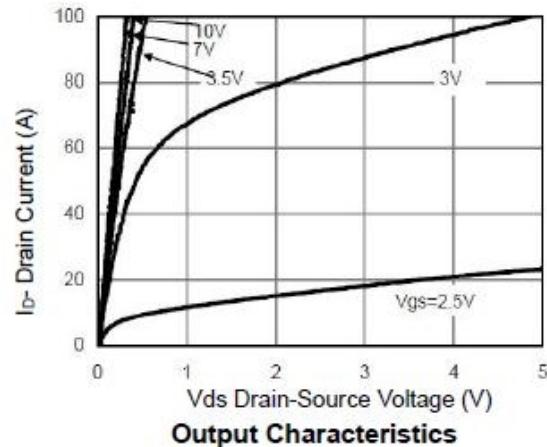
($T_A=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	$\text{BV}_{(\text{BR})\text{DSS}}$	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	30			V
Drain Cut-Off Current	I_{DSS}	$V_{DS} = 24\text{V}, V_{GS} = 0\text{V}$		1		μA
Gate-body leakage current	I_{GSS}	$V_{GS} = \pm 20\text{V}, V_{DS} = 0\text{V}$			± 0.1	μA
Gate-source threshold voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1	1.5	2.5	V
Drain-source on-resistance	$R_{DS(\text{on})}$	$V_{GS} = 10\text{V}, I_D = 20\text{A}$		2.8	3.5	$\text{m}\Omega$
		$V_{GS} = 4.5\text{V}, I_D = 10\text{A}$		5	6.6	
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS} = 10\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$		3000		pF
Output Capacitance	C_{oss}			450		
Reverse Transfer Capacitance	C_{rss}			400		
Switching Characteristics						
Total Gate Charge	Q_g	$V_{DS} = 15\text{V}, V_{GS} = 10\text{V}, I_D = 20\text{A}$		66		pF
Gate-Source Charge	Q_{gs}			7		
Gate-Drain Charge	Q_{gd}			17		
Turn-On Delay Time	$T_{d(on)}$	$V_{GS} = 10\text{V}, V_{DS} = 15, I_D = 20\text{A}, R_G = 3\Omega$		11		nS
Rise Time	T_r			14		
Turn-Off Delay Time	$T_{d(off)}$			36		
Fall Time	T_f			12		
Drain-Source Diode Characteristics						
Source-Drain Diode Forward Voltage	V_{SD}	$V_{GS} = 0\text{V}, I_S = 1\text{A}$			1.2	V

Note:

1. E_{AS} is tested at starting $T_j = 25^\circ\text{C}$, $V_{DD} = 15\text{V}$, $V_{GS} = 10\text{V}$, $L = 0.5\text{mH}$, $R_G = 25\Omega$;

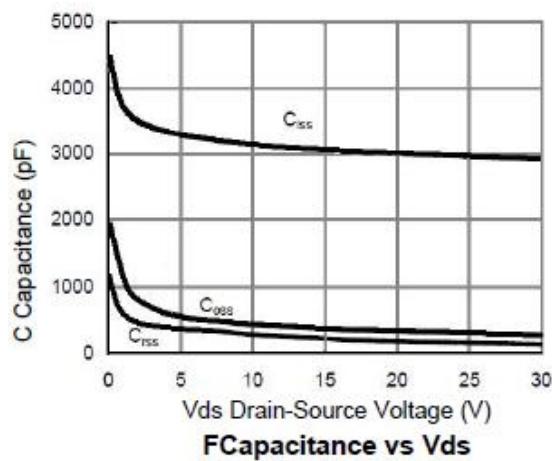
Typical Characteristics



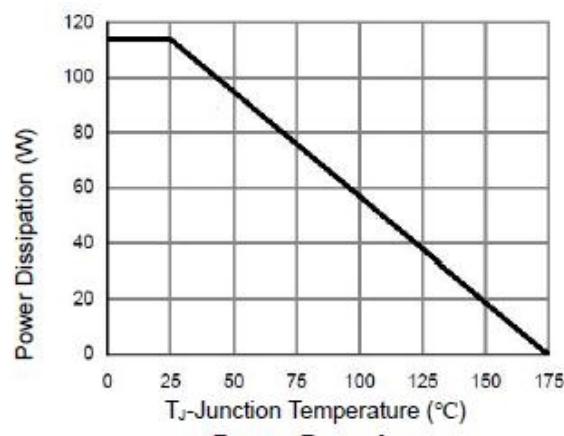


ZL MOSFET

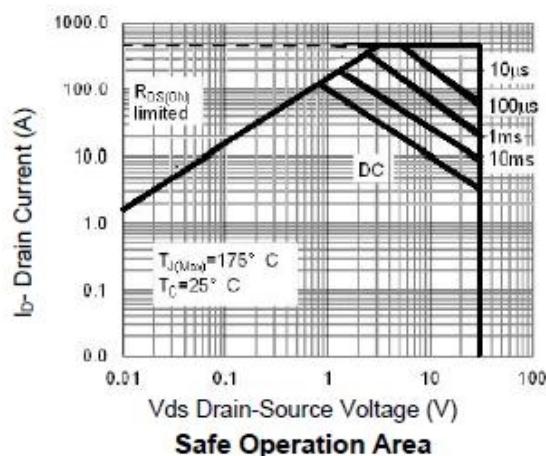
ZL30N03AT



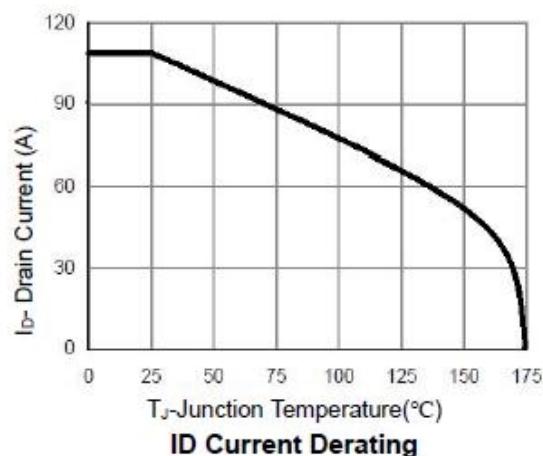
FCapacitance vs Vds



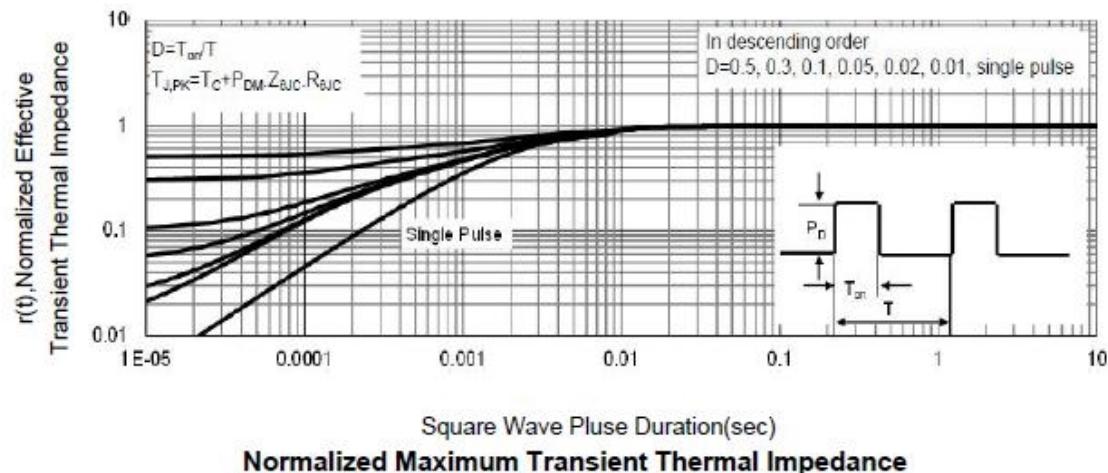
Power De-rating



Safe Operation Area

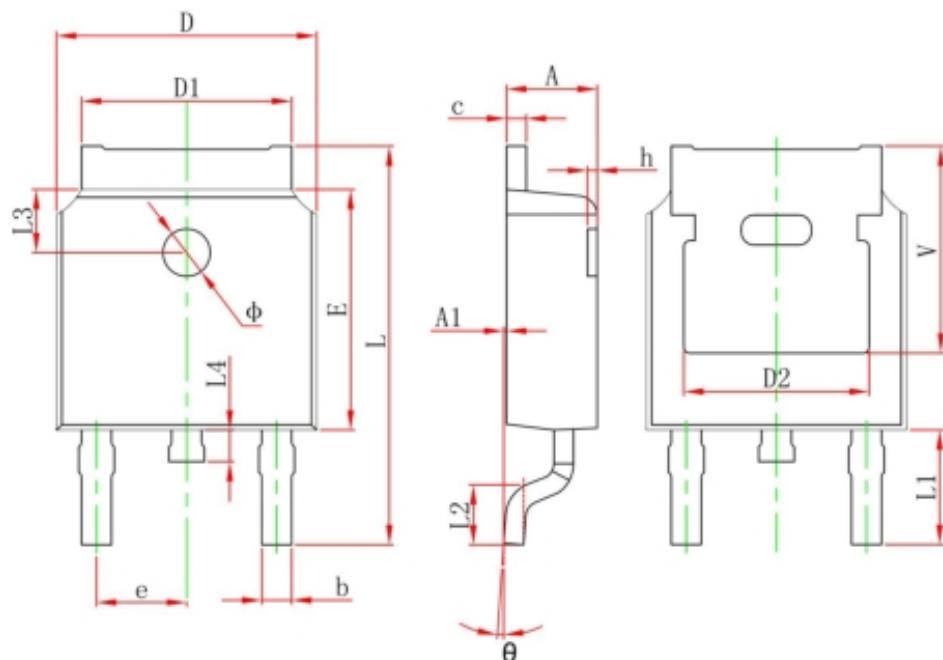


ID Current Derating



Normalized Maximum Transient Thermal Impedance

TO-252 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 REF.		0.190 REF.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 REF.		0.114 REF.	
L2	1.400	1.700	0.055	0.067
L3	1.600 REF.		0.063 REF.	
L4	0.600	1.000	0.024	0.039
ϕ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 REF.		0.211 REF.	